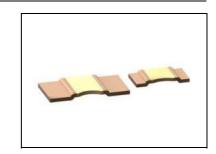
# Ultra low ohmic metal plate / high power type shunt resistors

**PSR** series Datasheet

#### Features

- 1) High power class up to 4 to 5W.
- 2) The lineup of ultra-low resistance value : correspondence from  $0.2 m\Omega$
- 3) Excellent temperature coefficiency.
- 4) Ideal for current detection under high current circuit.



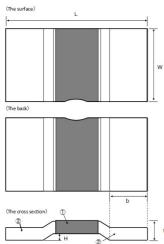
## Products list

	Size		Rated power		Resistance range	Temperature	Operating temperature		
Part No.	(mm)	(inch)	(70°C)	Tolerance	<b>3</b> .	coefficient*	range		
	(11111)	(111011)	(VV)		(mΩ)	(ppm / °C)	(°C)		
					0.3	±150			
PSR100	0400	R100 6432	2512	3W	3W	F(±1%)	0.5	±115	-55 ~ +170
PSKIOO	0432	2012	300				1.0	±100	
PSR400	10×5.2	3921	4W	F(±1%)	0.3,0.5	±175	-55 <b>~</b> +170		
P3R400	10^5.2	3921	400	F(±1/0)	1.0,2.0,3.0	±75	-55 ~ +170		
					0.2	±225			
PSR500	15×7.75	5931	5W	F(±1%)	0.3,0.4,0.5	±150	-55 <b>~</b> +170		
					1.0,2.0	±75			

\*(+20°C to +125°C)

(Unit:mm)

# Chip resistor dimensions and materials

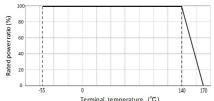


Part No.	L	W	Н	b	Resistance	t	Material					
					$0.3\mathrm{m}\Omega$	1.45±0.15						
					$0.5\mathrm{m}\Omega$	1.15±0.15	Cu/Mh					
PSR100	6.35±0.15	3.05±0.25	0.35±0.15	1.12±0.3	1.0 mΩ	0.75±0.15						
					2.0 mΩ	1.00±0.15	Ni/Cr					
				3.0 mΩ	0.75±0.15	INI/CI						
					$0.3\mathrm{m}\Omega$	1.85±0.15						
				$0.5\mathrm{m}\Omega$	1.30±0.15	Cu/Mn						
PSR400	10.0±0.3	5.2±0.3	5.2±0.3	0.5±0.15	0.5±0.15	0.5±0.15	0.5±0.15 2.0±0.6	2.0±0.6	1.0 mΩ	0.90±0.15		
								2.0 mΩ	1.10±0.15	Ni/Cr		
										$3.0\mathrm{m}\Omega$	0.90±0.15	INI/CI
		0.3 7.75±0.3 0.5±0.15			$0.2\mathrm{m}\Omega$	1.85±0.15						
					0.3 mΩ	1.40±0.15	Cu/Mn					
PSR500	SR500 15.0±0.3 7.75±0.3 0.5±0.15		051045	0.510.45	0.5±0.15	0.510.45	4.0±0.6	0.4 mΩ	1.15±0.15	Cu/IVII		
FOROU	10.0±0.3		ŒU.S   1.15±U.S	13.0±0.3   1.13±0.3   0.5±0.15   4		4.010.0	0.5 mΩ	1.05±0.15				
					1.0 mΩ	1.35±0.15	Ni/Cr					
					2.0 mΩ	0.90±0.15	INI/CI					

# Derating Curve

#### **■PSR100**

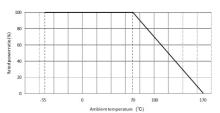
When the terminal temperature exceeds 140°C, power dissipation must be adjusted according to the derating curves below.



# Terminal temperature (°C)

#### ■PSR400 / 500

When the ambient temperature exceeds 70°C, power dissipation must be adjusted according to the derating curves below.



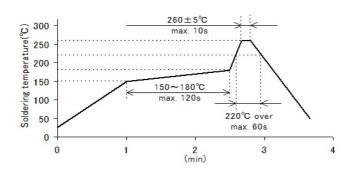
Design and specifications are subject to change without notice. Carefully check the specification sheet supplied with the product before using or ordering it. PSR series Datasheet

# Characteristics

Test items	Guaranteed value Resistor type	- Test conditions
Resistance	F(±1%)	Measuring method : 4probe per Bottom terminal
Variation of resistance with temperature	See P1	Measurement: +20/+125°C
Overload	±0.5%	Rated power×5, 5s
Solderability	Anew uniform coating of minimum of 95% of the surface being immersed and no soldering damage.	Flux: Rosin- Ethanol solution(25%weight) with diethylamine hydrochloride(3%weight) Soldering condition: 245±5°C Duration of immersion: 2.0±0.5s
Resistance to soldering heat	±1.0%  No remarkable abnormality on the appearance.	Soldering condition: 260±5°C Duration of immersion: 10±1s
Rapid change of temperature	±1.0%	Test temp:-55°C ~+155°C 5cycle
Damp heat, steady state	±0.5%	40 °C, 93%(Relative humidity) Test time: 1,000h~1,048h
ENDURANCE AT 140°C (terminal temperature) (PSR100)	±1.0%	Terminal temperature:140°C,Rated power 1.5h:ON – 0.5h:OFF Test time:1,000h~1,048h
ENDURANCE AT 70°C (ambient temperature)	±1.0%	Ambient temperature:70°C,Rated power 1.5h:ON – 0.5h:OFF Test time: 1,000h ~ 1,048h
Endurance at 170°C	±1.0%	170°C Test time: 1,000h~1,048h
Component solvent Resistance	±0.5%	23±5°C, Immersion cleaning, 10±1s. Solvent: 2-propanol
Bend strength of the end face plating	Without open	-

Compliance Standard(s): IEC60115-8 JISC 5201-1

# Solder conditions



Recommeded solder profile					
Reflow					
Temperature(°c) 260 220 150~180					
Time(s)	Peak 10s Max	60s	120s		

## (Note) About flow soldering

- ① This part has the structure that resistive element exposed.

  Therefore, the solder may be attached to resistive element if

  Flow soldering is used, and resistance value may be outside

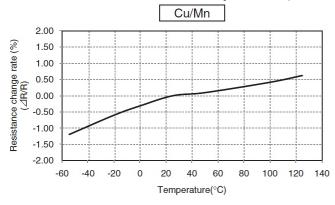
  of the spec.
- ② This part is ultra low ohmic resistoe. If the solder is not equally attached on the whole area between the bottom electrode and land pattem, resistance value may be outside of the spec.

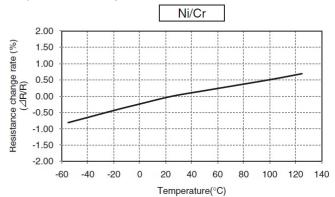
#### <Reference data>

# Characteristics

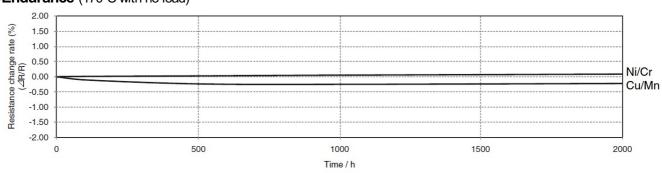
Туре	Resistance value (mΩ)	Thermal resistivity of product (°C /W)	Thermal EMF	Inductance
	0.3	4		
	0.5	7		
PSR100	1.0	14		<2nH
	2.0	20		
	3.0	30		
	0.3	4.5		
	0.5	8		
PSR400	1.0	15	2μV/°C Max.	
	2.0	16	ZµW C IVAX.	
	3.0	24		
	0.2	3		<3nH
	0.3	4.5		
PSR500	0.4	7		
	0.5	8		
	1.0	8		
	2.0	16		

# • Variation of resistance with temperature (Reference temperature is 20°C)

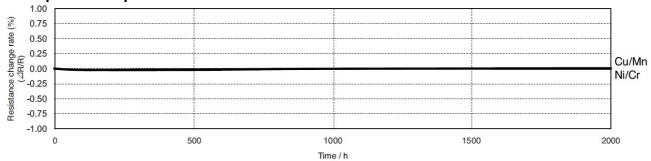




# ● Endurance (170°C with no load)

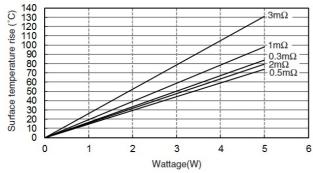


# Low temperature exposure

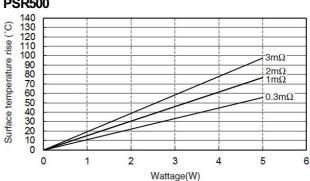


# ●Surface temp rise (Ta=25°C)

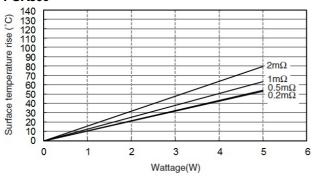
# **PSR100**



#### **PSR500**



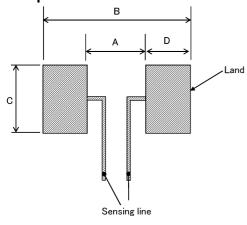
#### **PSR500**



Measurement condition of this date was taken out fromboard created under our regulation. Product with highest temperature was selected for the measurement.

Please contact us about test board and test conditions.

## Land pattern



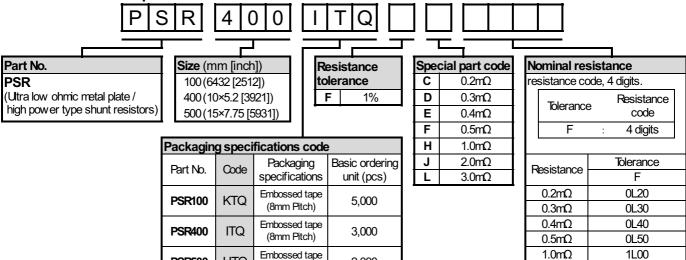
Type	Α	В	С	D
PSR100	3.40	7.00	3.40	1.80
PSR400	5.60	11.00	6.20	2.70
PSR500	5.60	16.00	8.75	5.20

<sup>\*</sup>This land pattern is only standard pattern. This does not gurantee the characteristics of the parts

2L00

3L00





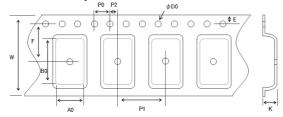
2,000

Embossed tape

(12mm Pitch)

# Tape dimensions

■ Embossed tape



**PSR500** 

HTQ

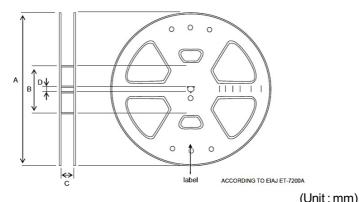
					(Unit:mm)
Part No.	W	F	Е	A0	B0
PSR100	12.0±0.2	5.5±0.05	1.75±0.1	3.5±0.1	6.6±0.1
PSR400	16.0±0.2	7.5±0.1	1.75±0.1	5.7±0.2	10.5±0.2
PSR500	24.0±0.2	11.5±0.1	1.75±0.1	8.3±0.2	15.6±0.2

2.0mΩ

3.0.mΩ

Part No.	D0	P0	P1	P2	K
PSR100	Ф1.5 <sup>+0.1</sup>	4.0±0.1	8.0±0.1	2.0±0.05	1.6±0.1
PSR400	Ф1.5 <sup>+0.1</sup>	4.0±0.1	8.0±0.1	2.0±0.1	2.3±0.1
PSR500	Ф1.5 <sup>+0.1</sup>	4.0±0.1	12.0±0.1	2.0±0.1	2.3±0.1

## Reel dimensions



Part No.	А	В	С	(OIIII.11111)
PSR100			13.4±1.0	
PSR400	Ф330±2.0	Ф100±1.0	17.4±1.0	Ф13.0±0.2
PSR500			25.4±1.0	

# **Notice**

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

Ì	JÁPAN	USA	EU	CHINA
	CLASSIII	CLASSIII	CLASS II b	СГУССШ
	CLASSIV	CLASSIII	CLASSIII	CLASSII

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

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